



# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

July 2011

Rev. 1.1.0

### GENERAL DESCRIPTION

The XRP2527 and XRP2528 devices are respectively single and dual channel integrated high-side power distribution switches with independent enables, fault flags and precise programmable current limit thresholds. A wide 1.8V to 5.5V input voltage range allows for operations from industry standard 1.8V, 3.3V and 5V power rails.

Current limit thresholds can be programmed accurately and independently for each channel via an external resistor. A simple setting optimizes the XRP2527 and XRP2528 for use in USB 2.0 or 3.0 compliant  $V_{BUS}$  power distribution architectures. These devices can be used in any self or bus powered USB applications. The power-switch rise and fall times are controlled to minimize current surges during turn on/off.

Built-in over current, under voltage lockout (UVLO), reverse current and over temperature protections insure safe operations under abnormal operating conditions.

XRP2527 and XRP2528 are offered respectively in RoHS compliant "green"/halogen free 3mm x 3mm 8-pin and 10-pin TDFN packages.

### APPLICATIONS

- Generic Power Switching
- Self Powered USB 2.0 and 3.0 Hubs
- USB Compliant  $V_{BUS}$  Power Distribution
- Audio-Video Equipments

### FEATURES

- Single / Dual Channel Current Switch
  - 1A per channel capable
  - 1.8V to 5.5V Input Voltage Range
- Programmable Over-Current Limit
  - 300mA to 1A set via external resistor
  - $\pm 8\%$  threshold accuracy at 1A
- USB 2.0 / 3.0 Compliant
- Individual Channel Enable
- Individual Channel Fault Flag Indicator
- Under voltage Lockout, Reverse Current and Thermal Shutdown Protection
- RoHS Compliant, Green / Halogen Free 8-Pin and 10-Pin TDFN Package

### TYPICAL APPLICATION DIAGRAM

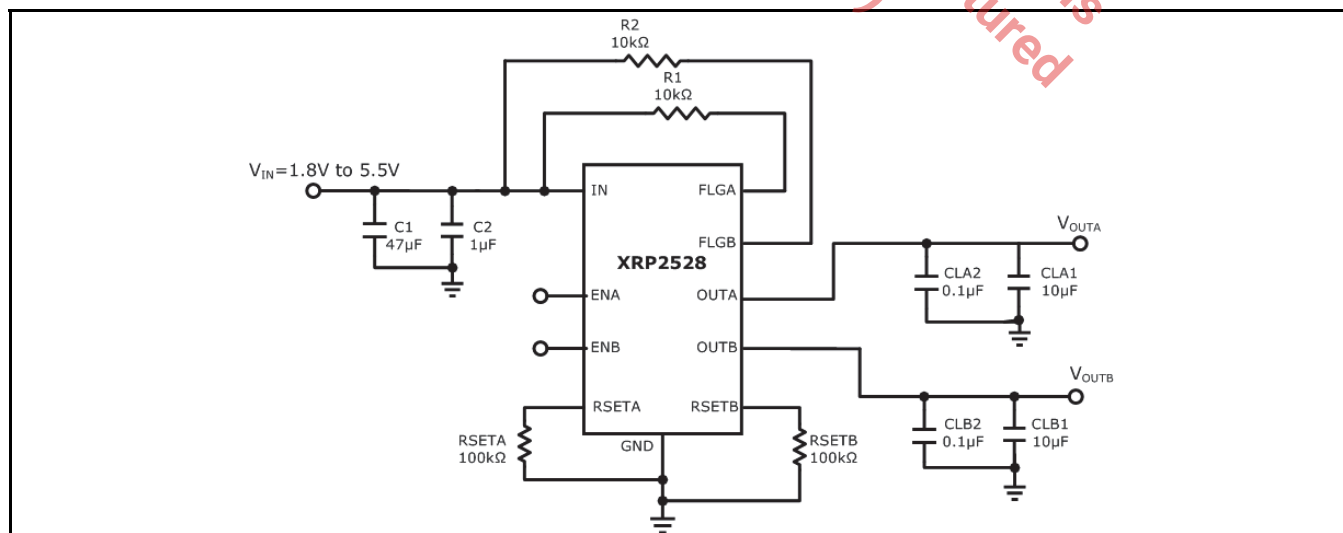


Fig. 1: XRP2528 Application Diagram



# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

### ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

$V_{IN}$  ..... -0.3V to 7.0V  
 $V_{EN}$ ,  $V_{FLG}$  ..... 7.0V  
Storage Temperature ..... -65°C to 150°C  
Power Dissipation ..... Internally Limited  
Lead Temperature (Soldering, 10 sec) ..... 300°C  
ESD Rating (HBM - Human Body Model) ..... 2kV  
ESD Rating (MM - Machine Model) ..... 200V

### OPERATING RATINGS

Input Voltage Range  $V_{IN}$  ..... 1.75V to 5.5V  
Junction Temperature Range ..... -40°C to 125°C  
Thermal Resistance  $\theta_{JA}$  .....  
TDFN-8L ..... 43.0°C/W  
TDFN-10L ..... 40.5°C/W

### ELECTRICAL SPECIFICATIONS

Specifications are for an Operating Junction Temperature of  $T_J = 25^\circ\text{C}$  only; limits applying over the full Operating Junction Temperature range are denoted by a "•". Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at  $T_J = 25^\circ\text{C}$ , and are provided for reference purposes only. Unless otherwise indicated,  $V_{IN} = 1.8\text{V}$  to  $5.5\text{V}$ ,  $C_{IN} = 47\mu\text{F}/1\mu\text{F}$ ,  $C_{OUT} = 10\mu\text{F}$ ,  $T_J = -40^\circ\text{C}$  to  $125^\circ\text{C}$ .

| Parameter                                      | Min. | Typ.                  | Max.  | Units            | Conditions                                                                                      |
|------------------------------------------------|------|-----------------------|-------|------------------|-------------------------------------------------------------------------------------------------|
| Input Supply Voltage                           | 1.8  |                       | 5.5   | V                | •                                                                                               |
| Input Quiescent Current                        |      | 80                    | 150   | $\mu\text{A}$    | • XRP2528, (Both Channels enabled)<br>• $V_{IN}=5\text{V}$ , $I_{OUT1} = I_{OUT2} = 0\text{mA}$ |
| Input Quiescent Current                        |      | 52                    | 100   | $\mu\text{A}$    | • XRP2527 and XRP2528 (1 Channel enabled)<br>• $V_{IN}=5\text{V}$ , $I_{OUT1} = 0\text{mA}$     |
| Input Shutdown Current                         |      |                       | 3     | $\mu\text{A}$    | • $V_{IN}=5\text{V}$ , Channel(s) disabled                                                      |
| Maximum Output Current per channel             | 1    |                       |       | A                | • XRP2527 and XRP2528. RSET=100k $\Omega$                                                       |
| Output Leakage Current                         |      |                       | 10    | $\mu\text{A}$    | • $V_{IN}=5\text{V}$ , $V_{OUT}=0\text{V}$ , Each channel, Switch off                           |
| Reverse Leakage Current                        |      |                       | 10    | $\mu\text{A}$    | • $V_{IN}=0\text{V}$ , $V_{OUT}=5\text{V}$ , Each channel, Switch off                           |
| Output MOSFET Resistance                       |      | 80                    | 140   | m $\Omega$       | • $I_{OUT}=0.3\text{A}$ , Each channel                                                          |
| Output turn-on delay                           |      | 1000                  |       | $\mu\text{s}$    | • $V_{IN}=5\text{V}$ , $R_L=10\Omega$ , $C_{OUT}=1\mu\text{F}$ , each output                    |
| Output turn-on rise time                       |      | 2000                  | 4000  | $\mu\text{s}$    | • $V_{IN}=5\text{V}$ , $R_L=10\Omega$ , $C_{OUT}=1\mu\text{F}$ , each output                    |
| Output turn-off delay                          |      | 10                    | 20    | $\mu\text{s}$    | • $V_{IN}=5\text{V}$ , $R_L=10\Omega$ , $C_{OUT}=1\mu\text{F}$ , each output                    |
| Output turn-off fall time                      |      | 22                    | 50    | $\mu\text{s}$    | • $V_{IN}=5\text{V}$ , $R_L=10\Omega$ , $C_{OUT}=1\mu\text{F}$ , each output                    |
| Current limit threshold                        | 0.90 | 1.15                  | 1.4   | A                | • $V_{IN} - V_{OUT} = 0.3\text{V}$ , RSET floating, USB 3.0                                     |
|                                                | 0.68 | 0.85                  | 1.02  | A                | • $V_{IN} - V_{OUT} = 0.3\text{V}$ , RSET tied to $V_{IN}$ , USB 2.0                            |
| Current limit threshold range                  | 0.3  |                       | 1     | A                |                                                                                                 |
| Current limit threshold accuracy               | 1    | 1.087                 | 1.174 | A                | • RSET=100k $\Omega$ for $I_{LIM(min)}=1\text{A}$ , $V_{IN}-V_{OUT}=0.3\text{V}$                |
| Short Circuit Current Limit                    |      | $0.66 \times I_{LIM}$ |       | A                | $V_{OUT} = 0\text{V}$                                                                           |
| Output Voltage Short Circuit Detect Threshold  |      | 925                   |       | mV               | Device operates in short circuit current limit mode when output voltage is below the threshold. |
| Safe Operating Area (SOA) Current Limit        |      | 3                     |       | A                |                                                                                                 |
| Over temperature shutdown threshold            |      | 135                   |       | $^\circ\text{C}$ | Temperature rising                                                                              |
| Over temperature shutdown threshold hysteresis |      | 10                    |       | $^\circ\text{C}$ | Temperature decreasing                                                                          |
| Under-voltage lockout threshold                | 1.55 | 1.68                  | 1.75  | V                | $V_{IN}$ rising or falling                                                                      |
| Under-voltage lockout hysteresis               |      | 50                    |       | mV               |                                                                                                 |
| FLG output logic low voltage                   |      | 100                   | 250   | mV               | $I_{FLG}=10\text{mA}$ , $V_{IN}=5.5\text{V}$                                                    |
| FLG output high leakage                        |      |                       | 1     | $\mu\text{A}$    |                                                                                                 |



# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

| Parameter                   | Min. | Typ. | Max. | Units   | Conditions                   |
|-----------------------------|------|------|------|---------|------------------------------|
| FLG blanking time           |      | 10   |      | ms      |                              |
| EN input logic high voltage | 1.5  |      |      | V       | •                            |
| EN input logic low voltage  |      |      | 0.5  | V       | •                            |
| EN input leakage current    | -1   | 0    | 1    | $\mu$ A | $V_{EN}=0V$ or $V_{EN}=5.5V$ |

### BLOCK DIAGRAM

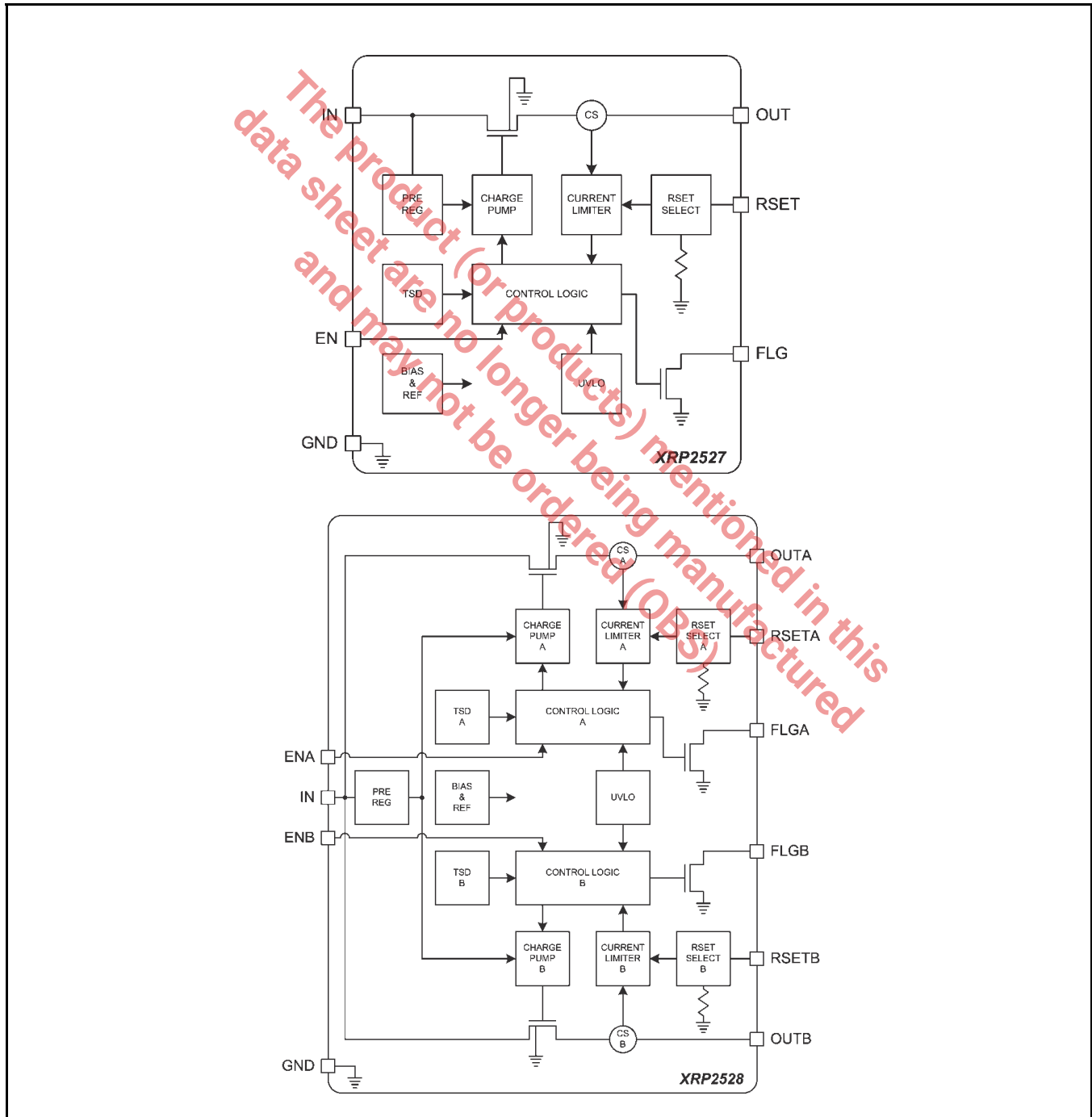


Fig. 2: XRP2527-XRP2528 Block Diagrams



# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

### PIN ASSIGNMENT

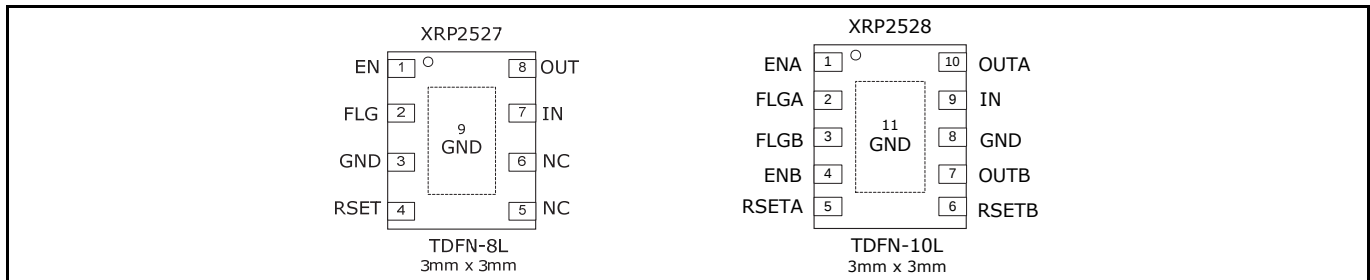


Fig. 3: XRP2527/28 Pin Assignment

### PIN DESCRIPTION – XRP2527

| Name | Pin Number | Description                                                                                                                                                                                         |
|------|------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EN   | 1          | Channel Enable Input                                                                                                                                                                                |
| FLG  | 2          | Error Flag Signal<br>Active low open drain output. Active on over-current, over-temperature or UVLO conditions.                                                                                     |
| GND  | 3          | Ground Signal                                                                                                                                                                                       |
| NC   | 5,6        | No Connect                                                                                                                                                                                          |
| IN   | 7          | Voltage Input Pin                                                                                                                                                                                   |
| OUT  | 8          | Voltage Output Pin                                                                                                                                                                                  |
| RSET | 4          | Current Limiting Threshold setting<br>RSET floating: USB 3.0 current limit settings<br>RSET tied to IN: USB 2.0 current limit settings<br>RSET tied to GND via resistor R: Adjustable current limit |

### PIN DESCRIPTION – XRP2528

| Name              | Pin Number | Description                                                                                                                                                                                         |
|-------------------|------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EN <sub>x</sub>   | 1,4        | Channel Enable Input                                                                                                                                                                                |
| FLG <sub>x</sub>  | 2,3        | Error Flag Signal<br>Active low open drain output. Active on over-current, over-temperature or UVLO conditions.                                                                                     |
| GND               | 8          | Ground Signal                                                                                                                                                                                       |
| IN                | 9          | Voltage Input Pin                                                                                                                                                                                   |
| OUT <sub>x</sub>  | 7,10       | Voltage Output Pin                                                                                                                                                                                  |
| RSET <sub>x</sub> | 5,6        | Current Limiting Threshold setting<br>RSET floating: USB 3.0 current limit settings<br>RSET tied to IN: USB 2.0 current limit settings<br>RSET tied to GND via resistor R: Adjustable current limit |

### ORDERING INFORMATION

| Part Number      | Temperature Range           | Marking              | Package | Packing Quantity | Note 1                        | Note 2                        |
|------------------|-----------------------------|----------------------|---------|------------------|-------------------------------|-------------------------------|
| XRP2527IHB-1-F   | -40°C≤T <sub>A</sub> ≤+85°C | 2527I<br>YYWW 1<br>X | TDFN8   | Bulk             | Lead Free and<br>Halogen Free | Single Channel<br>Active high |
| XRP2527IHBTR-1-F |                             |                      |         | 2.5K/Tape & Reel |                               |                               |
| XRP2528IHB-1-F   | -40°C≤T <sub>A</sub> ≤+85°C | 2528I<br>YYWW 1<br>X | TDFN10  | Bulk             | Lead Free and<br>Halogen Free | Dual Channel<br>Active high   |
| XRP2528IHBTR-1-F |                             |                      |         | 2.5K/Tape & Reel |                               |                               |
| XRP2527EVB       | XRP2527 Evaluation Board    |                      |         |                  |                               |                               |
| XRP2528EVB       | XRP2528 Evaluation Board    |                      |         |                  |                               |                               |

“YY” = Year – “WW” = Work Week – “X” = Lot Number

### TYPICAL PERFORMANCE CHARACTERISTICS

All data taken at  $V_{IN} = 5V$ ,  $C_{IN} = 47\mu F/1\mu F$ ,  $C_{OUT} = 10\mu F$ ,  $T_J = T_A = 25^\circ C$ , unless otherwise specified - Schematic and BOM from Application Information section of this datasheet.

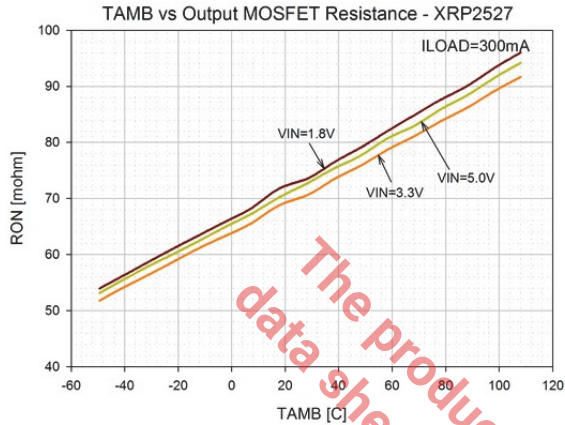


Fig. 4: Output On-Resistance vs. Temperature (XRP2527)

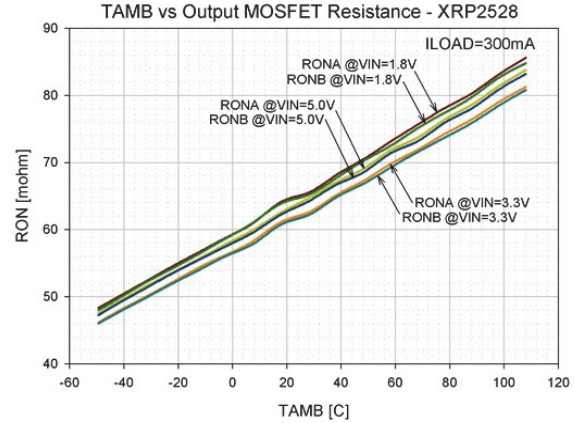


Fig. 5: Output On-Resistance vs. Temperature (XRP2528)

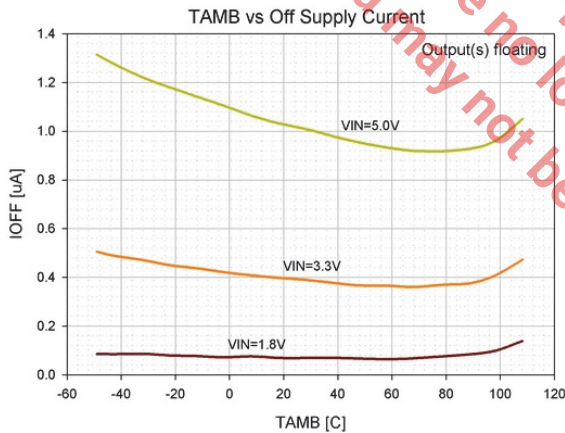


Fig. 6: Off Supply Current vs. Temperature

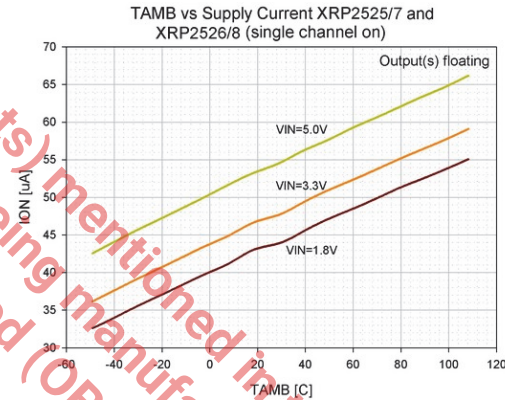


Fig. 7: Quiescent Current vs. Temperature XRP2527 and XRP2528 (1-channel on)

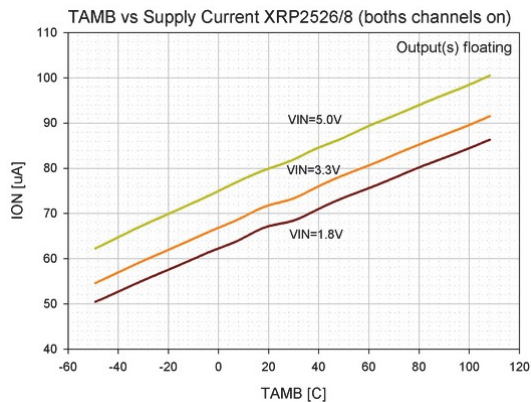


Fig. 8: Quiescent Current vs. Temperature XRP2528 (2-channels on)

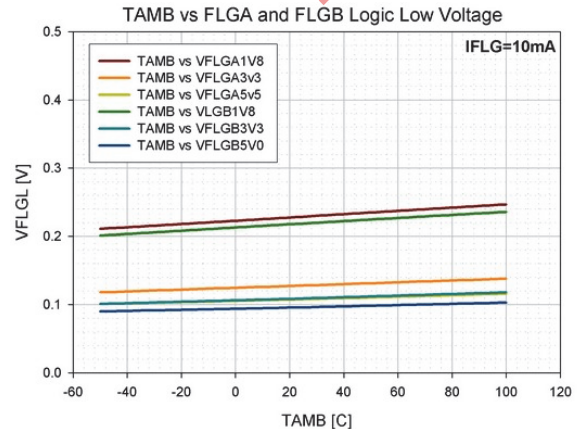


Fig. 9: FLG Logic Low Voltage vs. Temperature

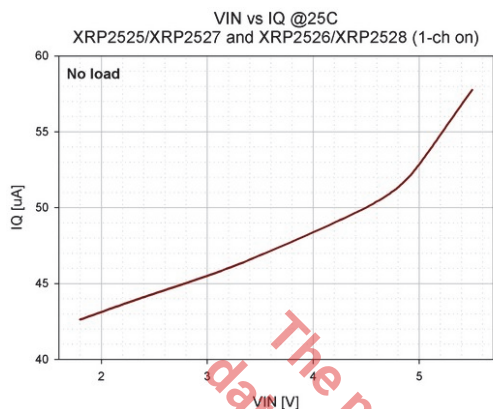


Fig. 10: Quiescent Current vs. Input Voltage  
XRP2527 and XRP2528 (1-channel on)

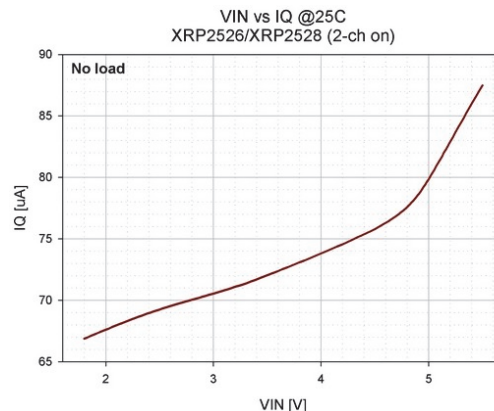


Fig. 11: Quiescent Current vs. Input Voltage  
XRP2528 (2-channels on)

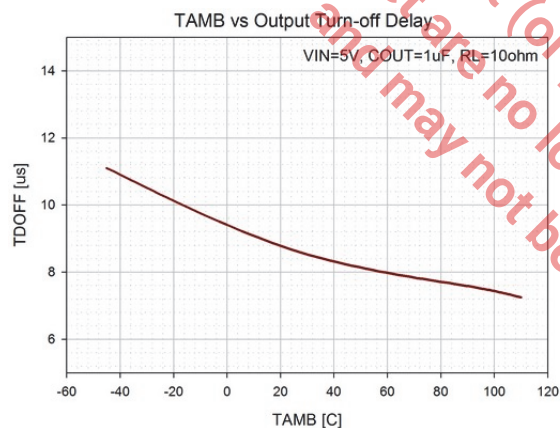


Fig. 12: Output Turn-Off Delay vs. Temperature

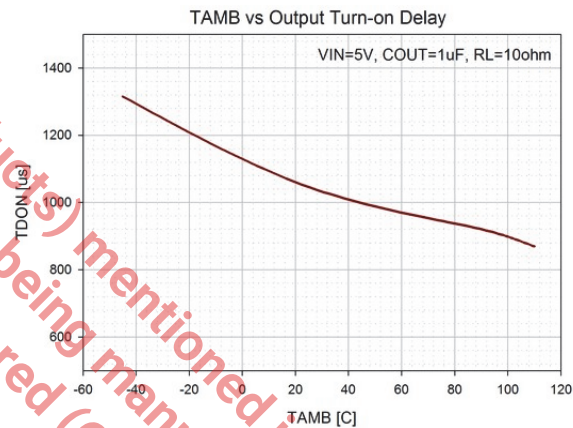


Fig. 13: Output Turn-on Delay vs. Temperature

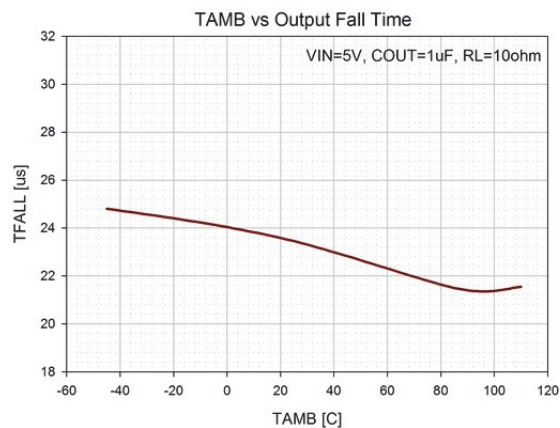


Fig. 14: Output Fall Time vs. Temperature

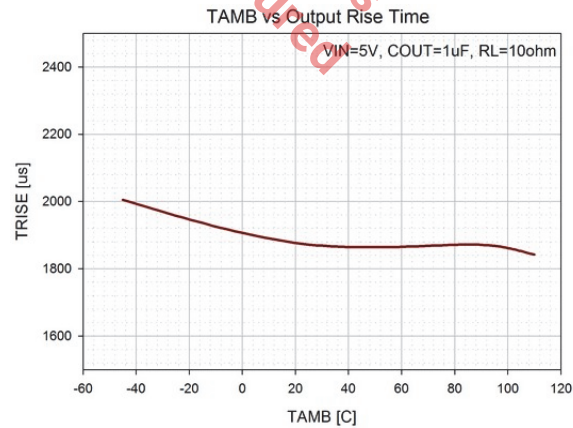


Fig. 15: Output Rise Time vs. Temperature

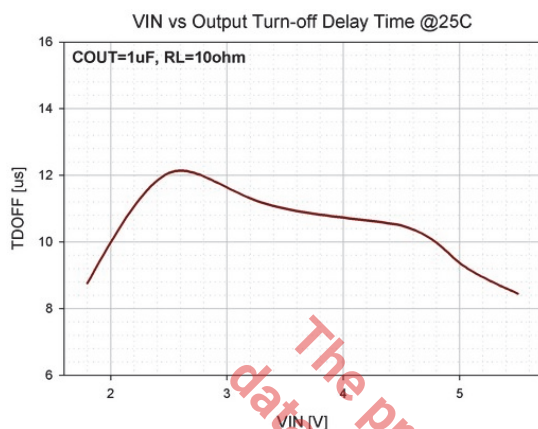


Fig. 16: Output Turn-Off Delay Time vs. Input Voltage

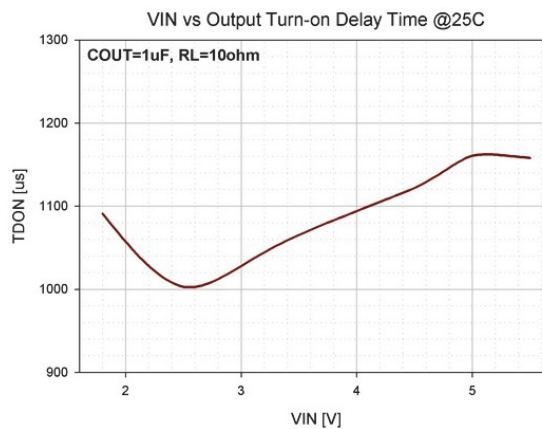


Fig. 17: Output Turn-On Delay Time vs. Input Voltage

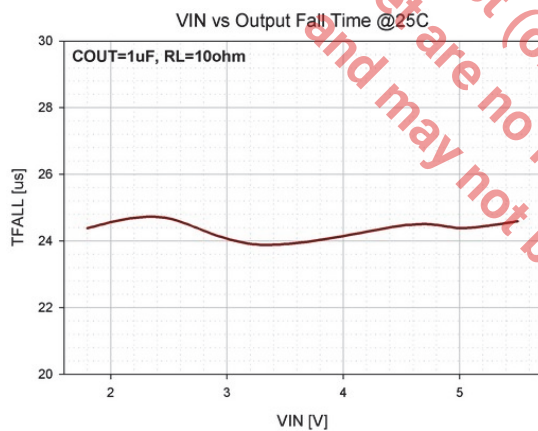


Fig. 18: Output Fall Time vs. Input Voltage

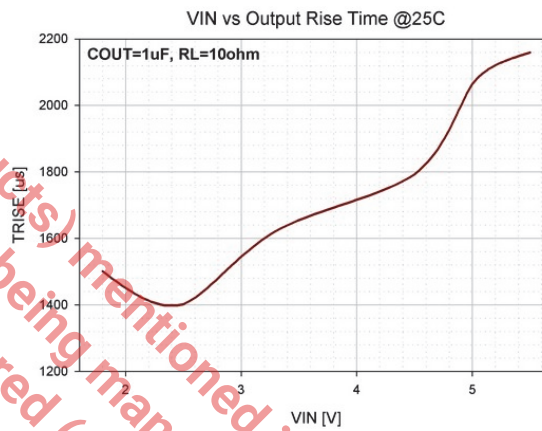


Fig. 19: Output Rise Time vs. Input Voltage

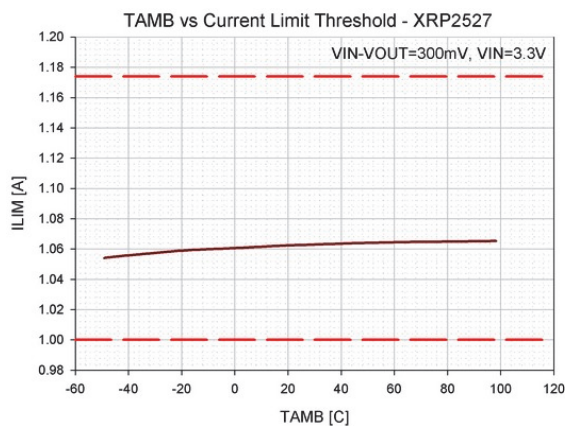


Fig. 20: Current Limit Threshold vs. Temperature (XRP2527)

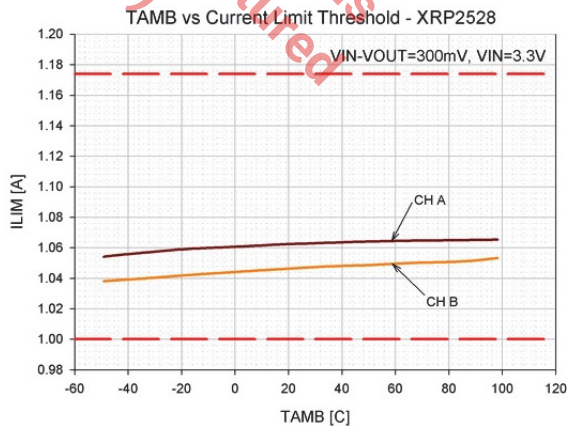


Fig. 21: Current Limit Threshold vs. Temperature (XRP2528)

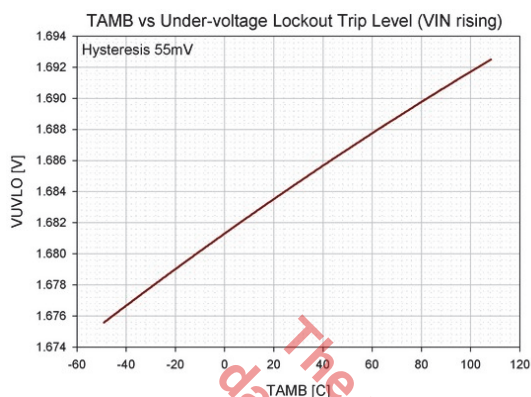


Fig. 22: Under-voltage lockout trip level vs. Temperature (VIN Rising)

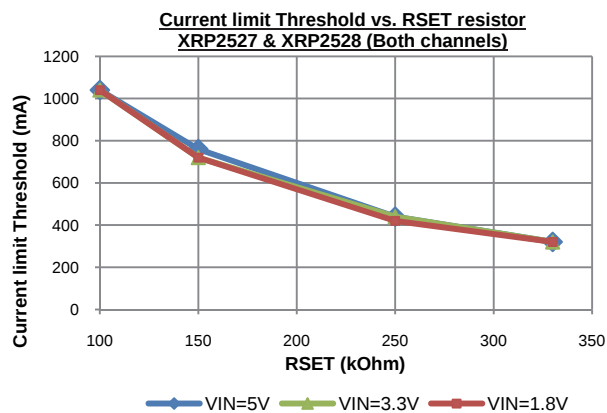


Fig. 23: Current Limit Threshold vs. RSET resistor value

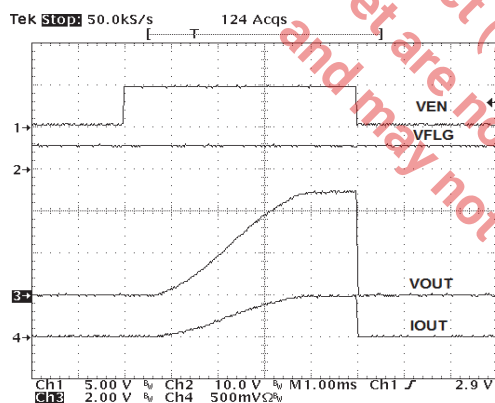


Fig. 24: Turn-On, Turn-Off Characteristics (XRP2528):  
COUT = 1uF, Rload = 10Ω, RSET floating

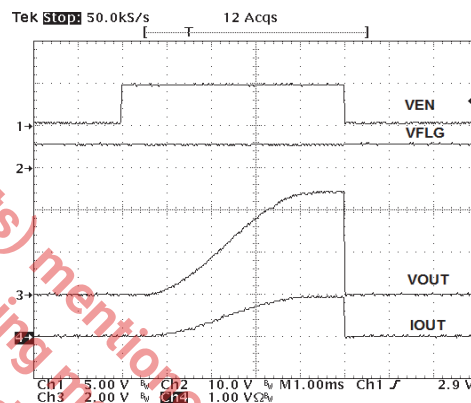


Fig. 25: Turn-On, Turn-Off Characteristics (XRP2528):  
COUT = 1uF, Rload = 5Ω, RSET floating

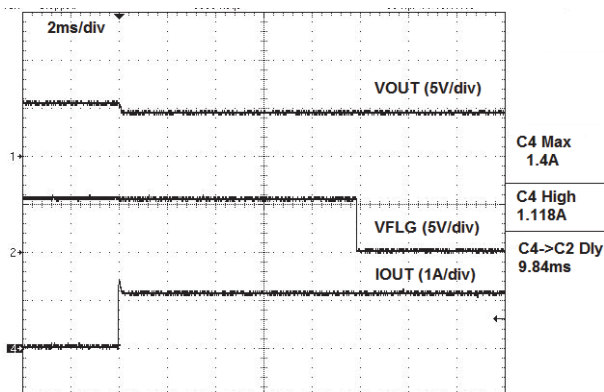


Fig. 26: Current Limit Operation (XRP2527):  
VIN=5.5V, Rload = 3.9Ω, USB3.0

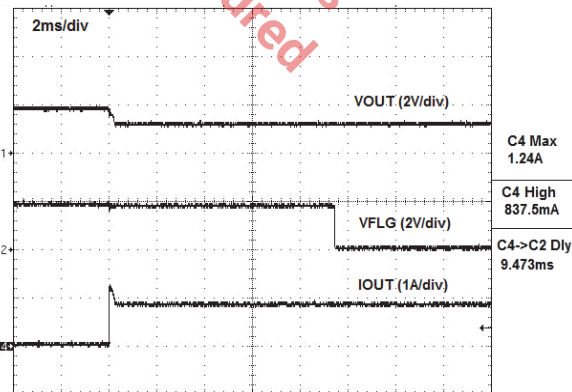


Fig. 27: Current Limit Operation (XRP2528):  
VIN=1.8V, Rload = 1.5Ω, USB2.0

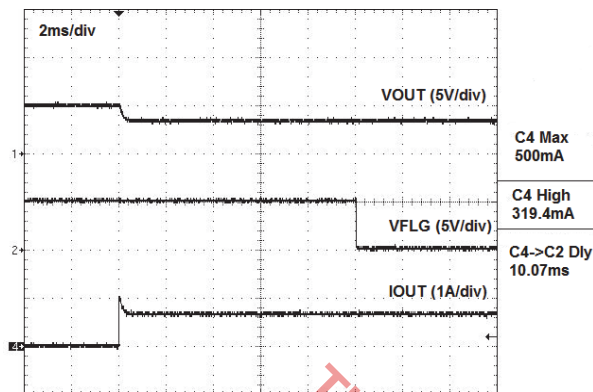


Fig. 28: Current Limit Operation (XRP2527):  
VIN=5V, Rload = 10Ω, RSET = 330kΩ

### THEORY OF OPERATION

The XRP2527 and XRP2528 devices are respectively single and dual channel integrated high-side power distribution switches with programmable current limit threshold feature. They can be used in any self or bus powered USB applications and are compliant with the latest USB 3.0 specifications. The reverse current protection feature prevents current to flow from OUT to IN when the device is disabled.

### INPUT & OUTPUT

Placing bulk capacitances of at least 47μF and 10μF at the input and output pins respectively reduces power supply transients under heavy current load conditions.

It is important to place a 1μF ceramic bypass capacitor from IN to GND as close as possible to the device in order to control supply transients.

Furthermore, bypassing the output pin with a 0.1μF to 1μF ceramic capacitor improves the device response to short-circuit transients.

### ERROR FLAG

The error flag signal (FLG<sub>x</sub> output pin) is an open-drain output and is pulled low (active low) upon detection of the following conditions:

- Over-current condition
- Over-temperature condition
- Under voltage lockout condition

Over-temperature and under voltage lockout conditions are flagged immediately while the output over – current condition is reported if continuously persistent for longer than the blanking time of 10ms. The blanking time prevents erroneous reporting of current faults due to brief output current spikes.

Once activated, the error flag signal remains low until all fault conditions have been removed and is independent for each individual channel.

### CURRENT LIMIT

The current limit feature protects the output MOSFET switches from damages resulting from undesirable short circuit conditions or excess inrush current, which is often encountered during hot plug-in. Upon detection of overcurrent condition, the output current is limited to a constant current limit threshold value and the output voltage is reduced accordingly. Triggering the current limit function is signaled by the Error Flag after 10ms of blanking time period.

The minimum current limit threshold can be programmed from 300mA to 1A set via an external resistor at the RSET pin. If RSET pin is left floating, then the device is set to USB 3.0 current limit setting. For USB 2.0 current limit setting, the RSET pin must be tied to VIN. The current limit threshold value is set using the resistor at RSET pin by the following equation:



## XRP2527 - XRP2528

### Single / Dual Channel Adjustable Current Power Distribution Switch

$$I_{LIM} \text{ typ. [A]} = \frac{108.7}{R_{SET}[\text{kohm}]}$$

Please note that the allowed values for RSET resistor are  $100\text{kohm} < R_{SET} < 330\text{kohm}$ .

#### UNDER-VOLTAGE LOCKOUT

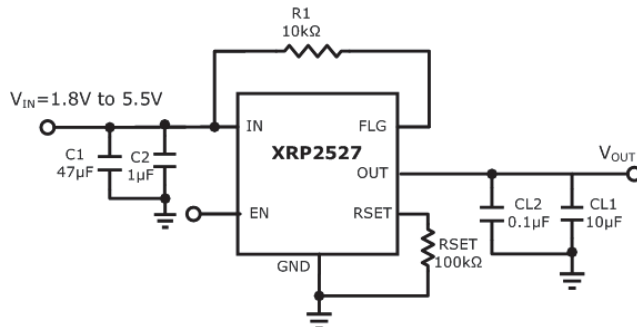
Under-voltage lockout function (UVLO) keeps the internal power switch from being turned on until the power supply has reached at least 1.68V, even if the switch is enabled. Upon detection of an input voltage below approximately 1.68V, the power switch is turned off while a fault condition is reported by the error flag signal.

#### THERMAL PROTECTION

Internal thermal sensing circuitry monitors the operating temperature of the device for each channel independently. Upon detection of a temperature in excess of 135°C, the power switch for the given channel is disabled

preventing any damages to the device while a fault condition is reported by the error flag signal. A built-in 10°C hysteresis allows the device to cool down to 125°C before resuming normal operations on the faulty channel at which point the error flag signal is cleared.

#### TEST CIRCUIT



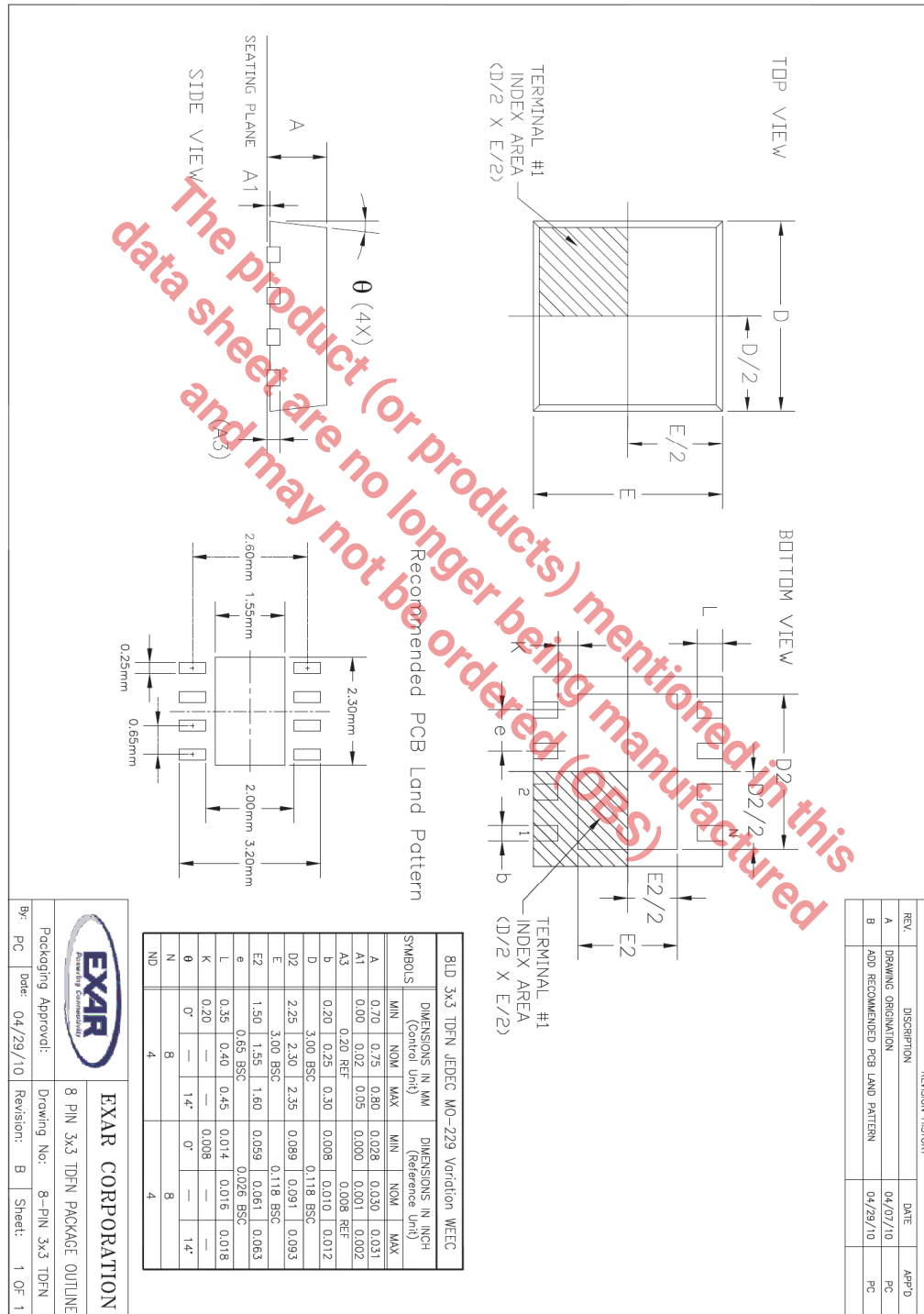


# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

### PACKAGE SPECIFICATION

#### 8-PIN TDFN

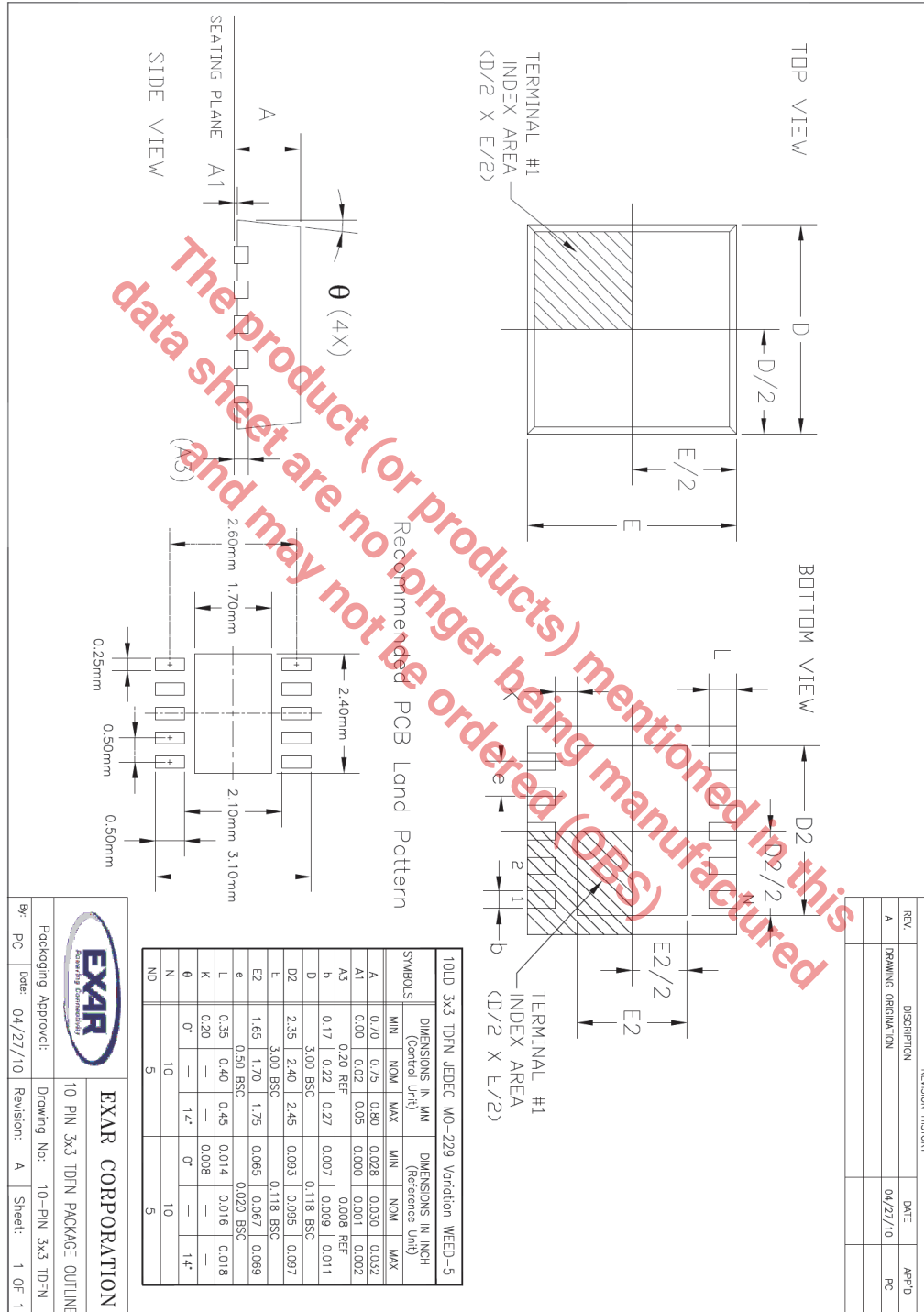




# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

### 10-PIN TDFN





# XRP2527 - XRP2528

## Single / Dual Channel Adjustable Current Power Distribution Switch

### REVISION HISTORY

| Revision | Date       | Description                         |
|----------|------------|-------------------------------------|
| 1.0.0    | 05/13/2011 | Initial release of datasheet        |
| 1.1.0    | 07/14/2011 | Corrections of typographical errors |
|          |            |                                     |

### FOR FURTHER ASSISTANCE

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